



IR Detector for Mid Range Proximity Sensor



20953

DESCRIPTION

The TSSP77P38 is a compact infrared detector module for proximity sensing application. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

The length of the detector's output pulse varies in proportion to the amount of light reflected from the object being detected.

FEATURES

- Up to 2 m for proximity sensing
- Very low supply current
- Photo detector and preamplifier in one package
- Shielding against EMI
- Supply voltage: 2.0 V to 5.5 V
- Visible light is suppressed by IR filter
- Capable of side or top view
- Insensitive to supply voltage ripple and noise
- Two lenses for high sensitivity and wide receiving angle
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

APPLICATIONS

- Object approach detection for activation of displays and user consoles, signaling of alarms, etc.
- Simple gesture controls
- Differentiation of car arrival, static, car departure in parking lots
- Reflective sensors for toilet flush
- Navigational sensor for robotics

LINKS TO ADDITIONAL RESOURCES



Product Page

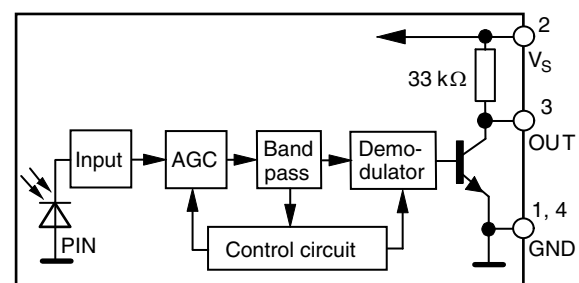


Marking

DESIGN SUPPORT TOOLS

- [3D models](#)
- [Window size calculator](#)

BLOCK DIAGRAM



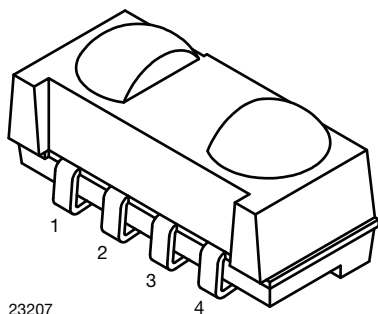
20445-8



MECHANICAL DATA

Pinning:

1, 4 = GND, 2 = V_S , 3 = OUT



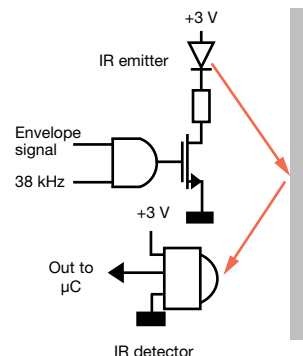
ORDERING CODE

Taping:

TSSP77P38TT - top view taped, 2200 pcs/reel

TSSP77P38TR - side view taped, 2300 pcs/reel

PROXIMITY SENSING



PARTS TABLE		
Carrier frequency	38 kHz	TSSP77P38
Package		Heimdall
Pinning		1, 4 = GND, 2 = V_S , 3 = OUT
Dimensions (mm)		6.8 W x 3.0 H x 3.2 D
Mounting		SMD
Application		Proximity sensors
Special options	<ul style="list-style-type: none"> Extended temperature range: www.vishay.com/doc?82738 Narrow optical filter: www.vishay.com/doc?81590 Wide optical filter: www.vishay.com/doc?82726 	

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		V_S	-0.3 to +6	V
Supply current		I_S	5	mA
Output voltage		V_O	-0.3 to ($V_S + 0.3$)	V
Output current		I_O	5	mA
Junction temperature		T_j	100	°C
Storage temperature range		T_{stg}	-25 to +85	°C
Operating temperature range		T_{amb}	-25 to +85	°C
Power consumption	$T_{amb} \leq 85^\circ\text{C}$	P_{tot}	10	mW

Note

- Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability



ELECTRICAL AND OPTICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		V_S	2.0	-	5.5	V
Supply current	$V_S = 3.3\text{ V}$, $E_e = 0$	I_{SD}	0.25	0.35	0.45	mA
	$E_v = 40\text{ klx}$, sunlight	I_{SH}	-	0.45	-	mA
Receiving distance	Direct line of sight, IR diode TSAL6200, $I_F = 50\text{ mA}$, test signal see Fig. 1	d	-	21	-	m
Output voltage low	$I_{OSL} = 0.5\text{ mA}$, $E_e = 0.7\text{ mW/m}^2$, test signal see Fig. 1	V_{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi} - 5/f_0 < t_{po} < t_{pi} + 5/f_0$, test signal see Fig. 1	$E_e\text{ min.}$	-	0.15	0.3	mW/m^2
Maximum irradiance	Pulse width tolerance: $t_{pi} - 5/f_0 < t_{po} < t_{pi} + 5/f_0$, test signal see Fig. 1	$E_e\text{ max.}$	30	-	-	W/m^2
Directivity	Angle of half receiving distance	$\Phi_{1/2}$	-	± 50	-	$^{\circ}$

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

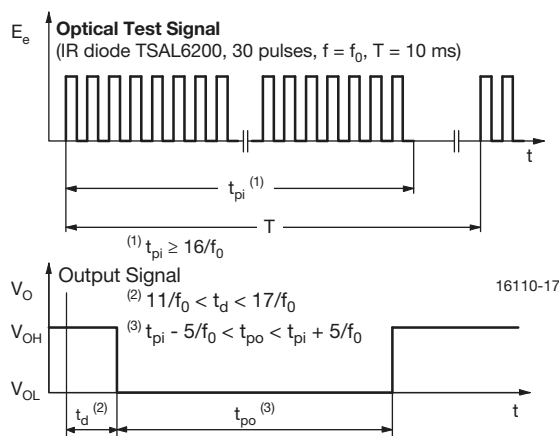


Fig. 1 - Output Active Low

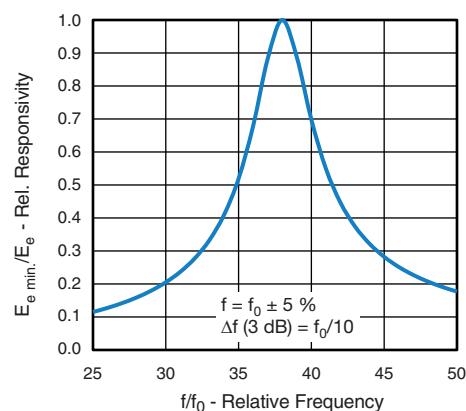


Fig. 3 - Frequency Dependence of Responsivity

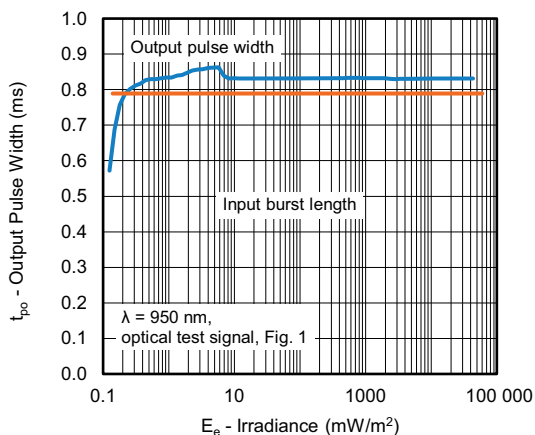


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

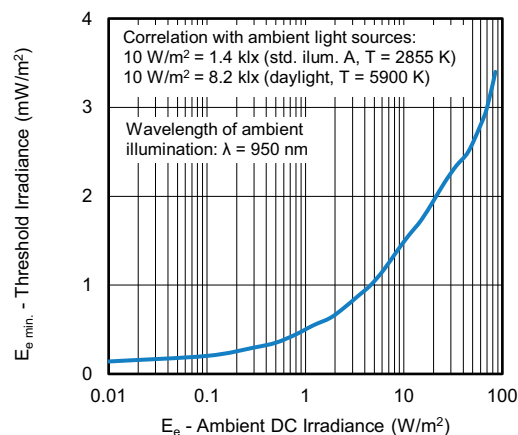


Fig. 4 - Sensitivity in Bright Ambient

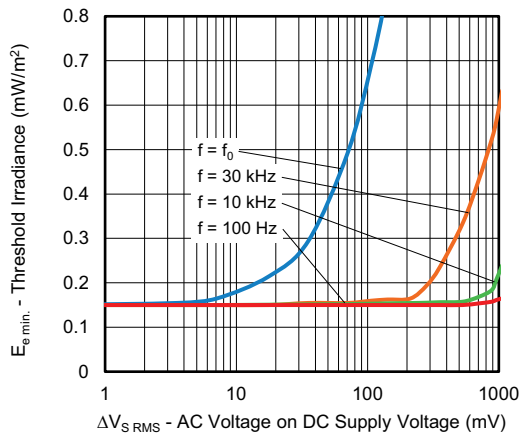


Fig. 5 - Sensitivity vs. Supply Voltage Disturbances

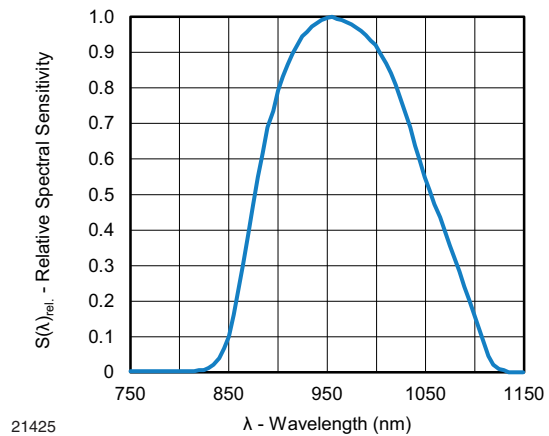


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

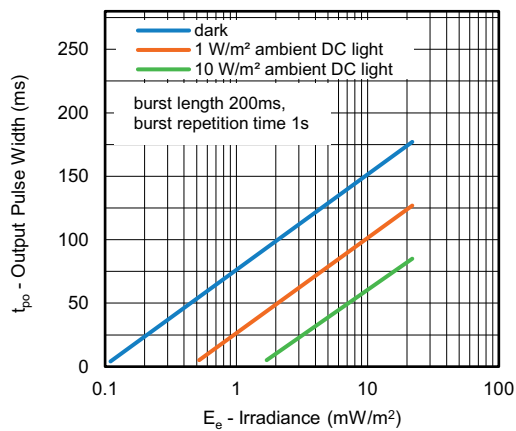


Fig. 6 - Output Pulse Width vs. Irradiance

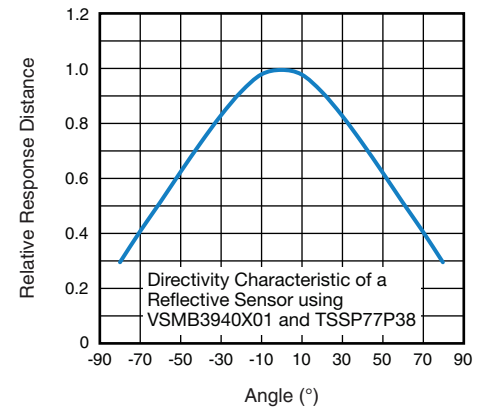


Fig. 9 - Angle Characteristic

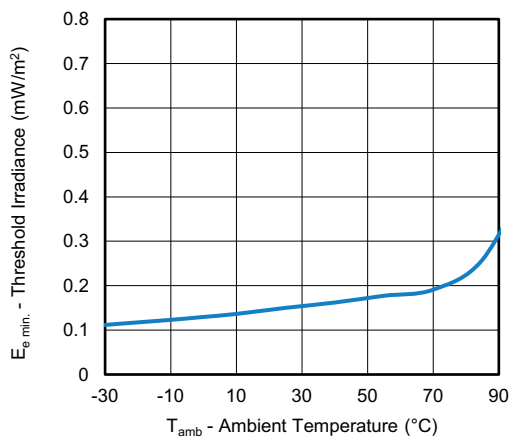


Fig. 7 - Sensitivity vs. Ambient Temperature

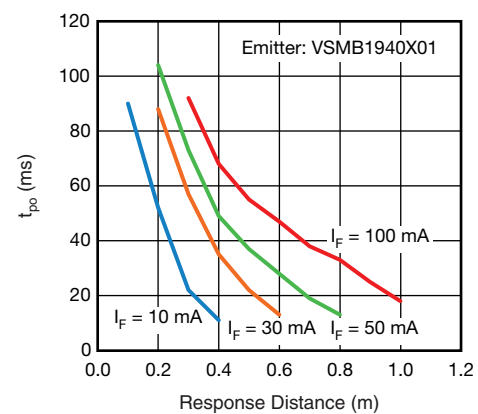


Fig. 10 - t_{po} vs. Distance Kodak Gray Card Plus 15 %

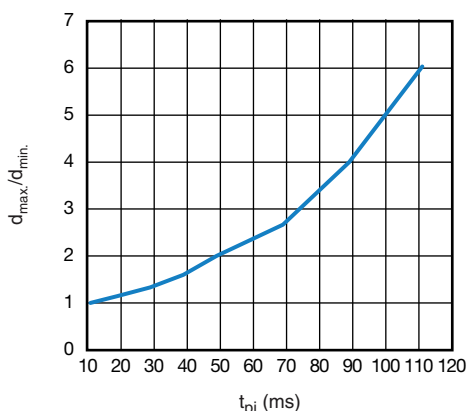


Fig. 11 - Dynamic Range of Sensor vs. t_{pi}

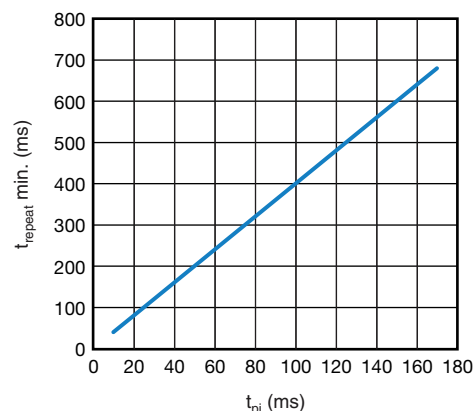
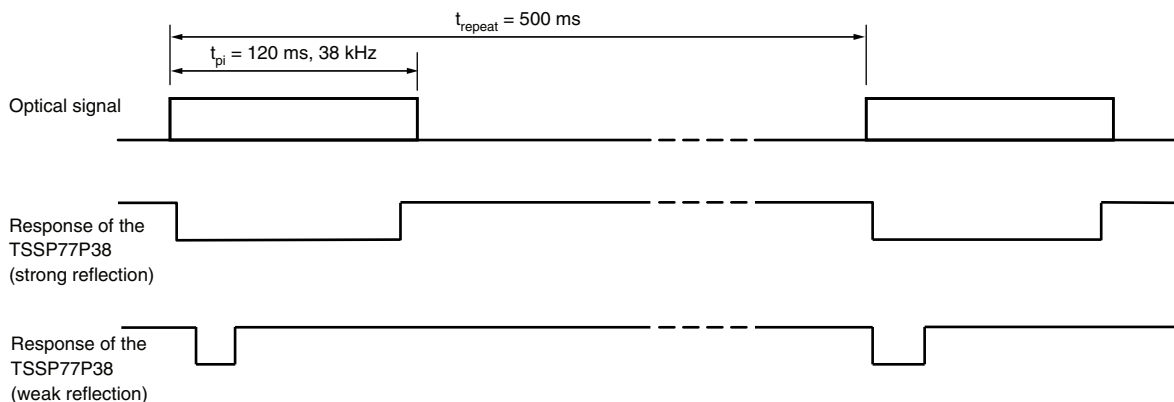


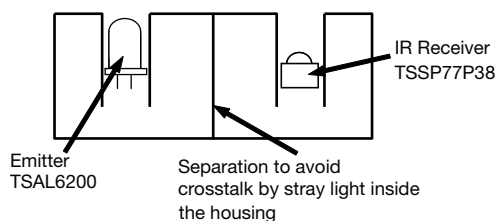
Fig. 12 - Max. Rate of Bursts

The typical application of the TSSP77P38 is a reflective sensor with analog information contained in its output. Such a sensor is evaluating the time required by the AGC to suppress a quasi continuous signal. The time required to suppress such a signal is longer when the signal is strong than when the signal is weak, resulting in a pulse length corresponding to the distance of an object from the sensor. This kind of analog information can be evaluated by a microcontroller. The absolute amount of reflected light depends much on the environment and is not evaluated. Only sudden changes of the amount of reflected light, and therefore changes in the pulse width, are evaluated using this application.

Example of a signal pattern:



Example for a sensor hardware:

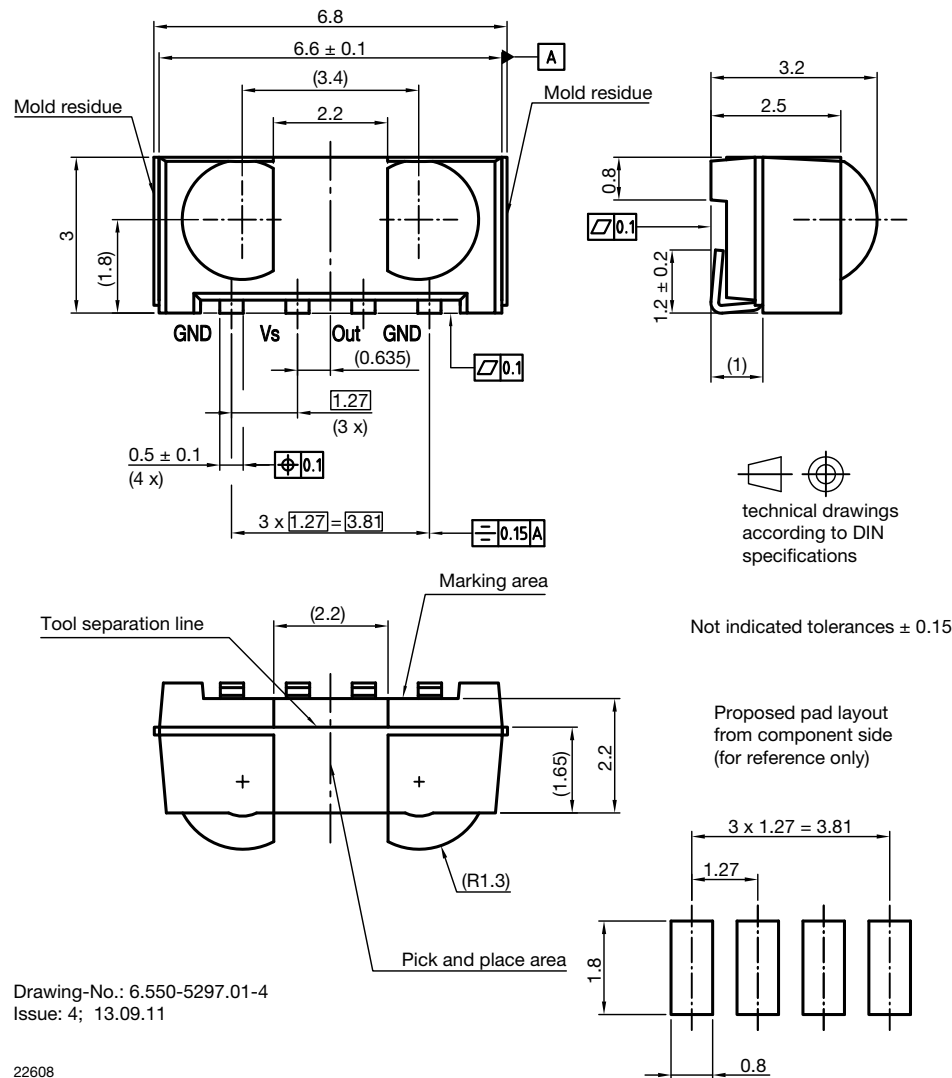


The logarithmic characteristic of the AGC in the TSSP77P38 results in an almost linear relationship between distance and pulse width. Ambient light has also some impact to the pulse width of this kind of sensor, making the pulse shorter.

There should be no common window in front of the emitter and receiver in order to avoid crosstalk by guided light through the window.



PACKAGE DIMENSIONS in millimeters

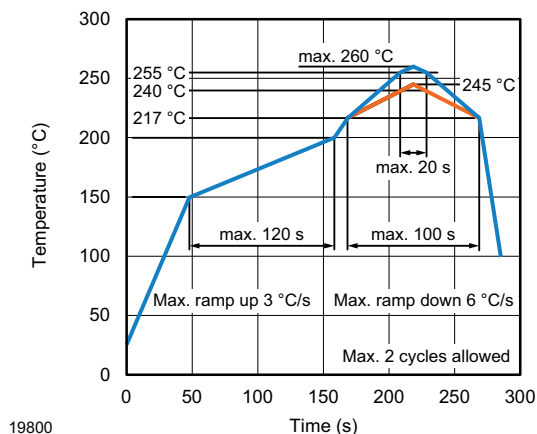


**ASSEMBLY INSTRUCTIONS****Reflow Soldering**

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

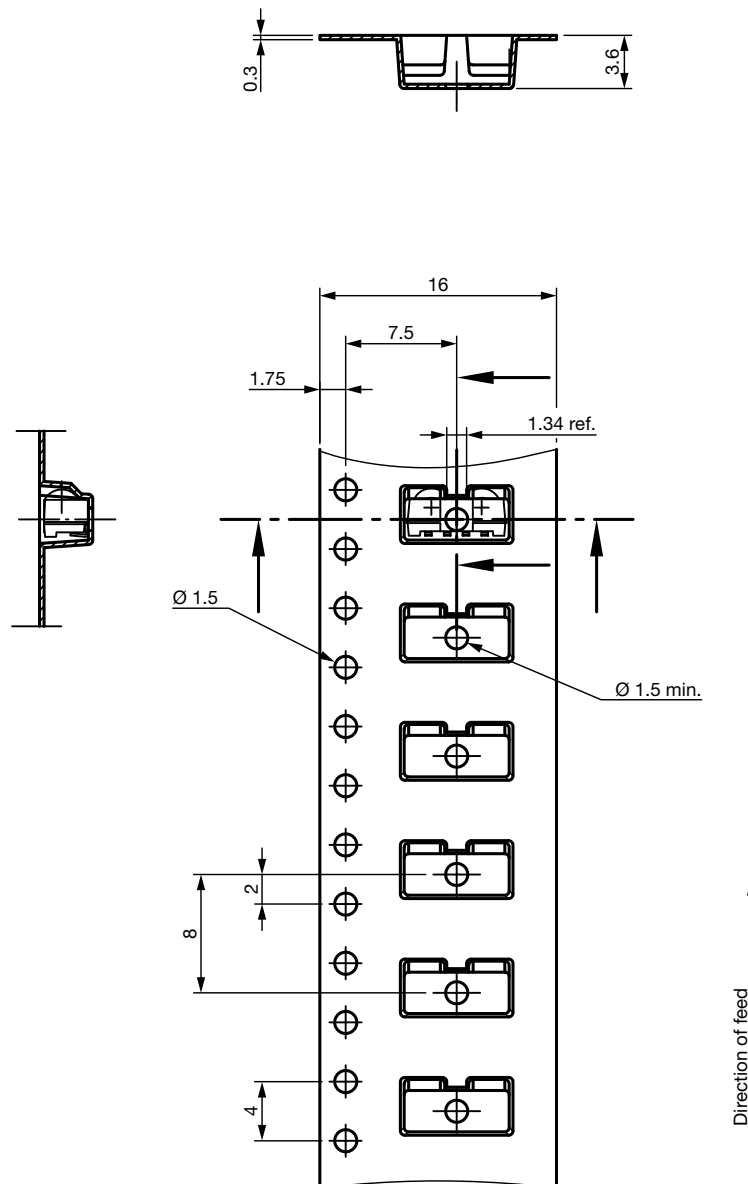
Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

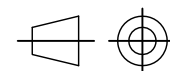
VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSSP77P38TR DIMENSIONS in millimeters



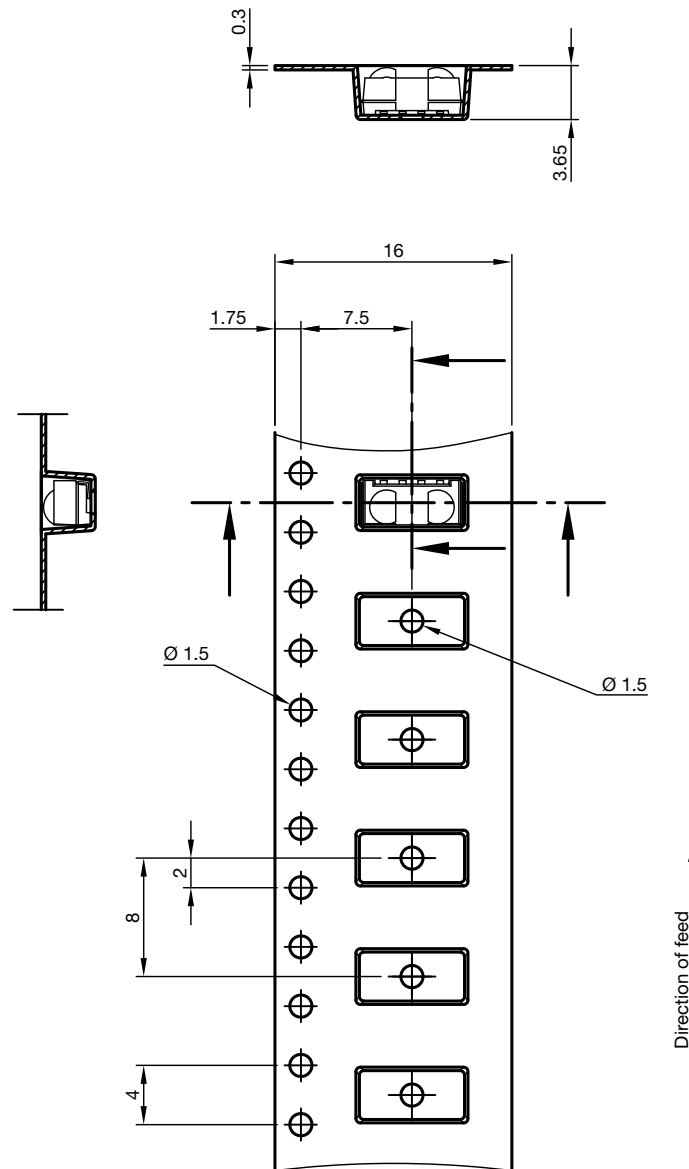
Drawing-No.: 9.700-5337.01-4
Issue: 2; 06.10.15



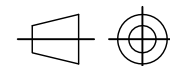
technical drawings
according to DIN
specifications



TAPING VERSION TSSP77P38TT DIMENSIONS in millimeters



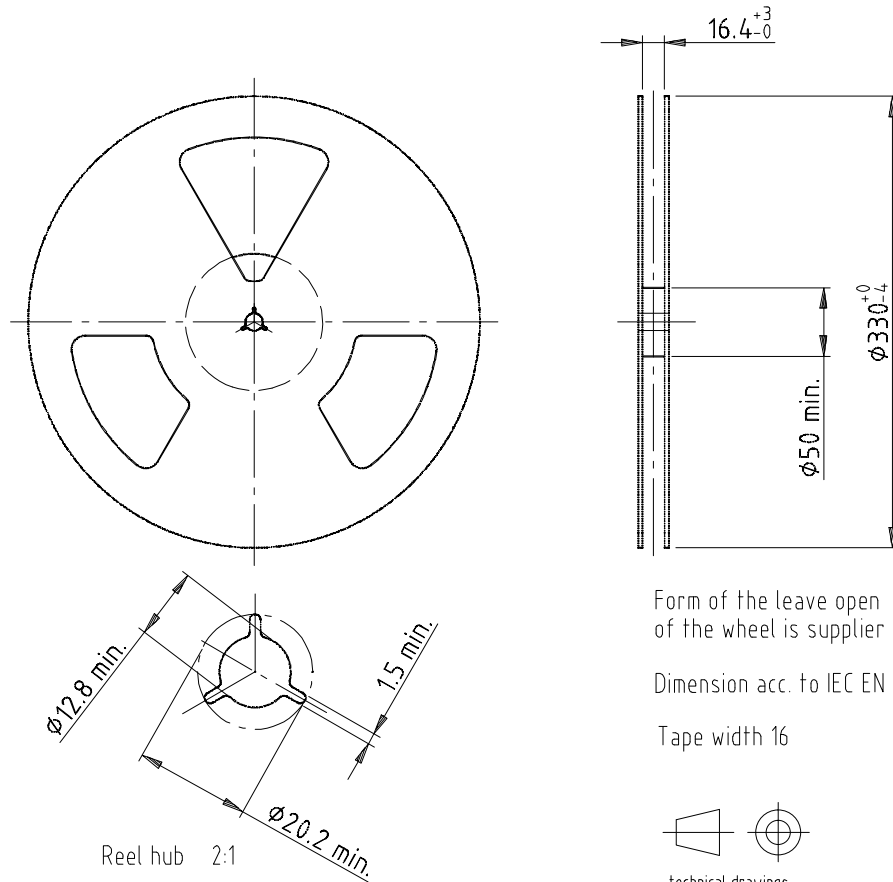
Drawing-No.: 9.700-5338.01-4
Issue: 4; 12.06.13



technical drawings
according to DIN
specifications



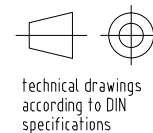
REEL DIMENSIONS in millimeters



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16

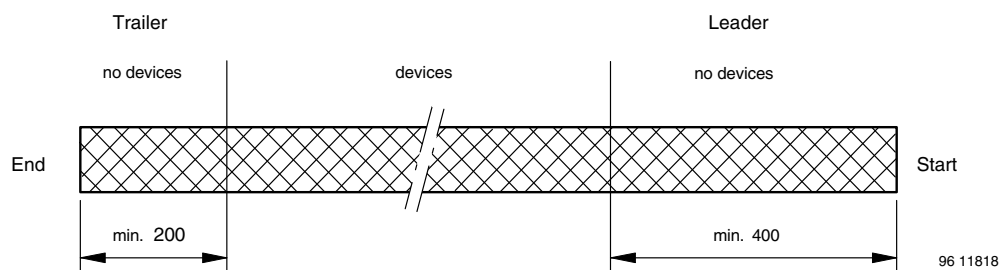


Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3

0.1 N to 1.3 N

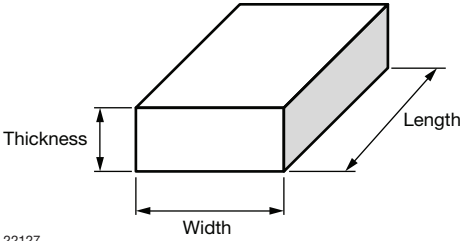
300 \pm 10 mm/min.

165° to 180° peel angle



OUTER PACKAGING

The sealed reel is packed into a pizza box.

CARTON BOX DIMENSIONS in millimeters			
			
	THICKNESS	WIDTH	LENGTH
Pizza box (SMD and heimdall) (taping in reels)	50	340	340

LABEL

Standard bar code labels for finished goods

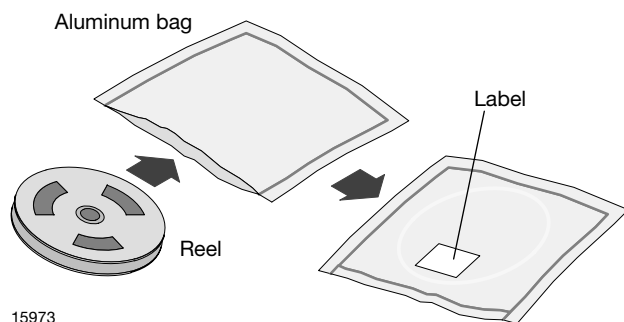
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods)		
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17



DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

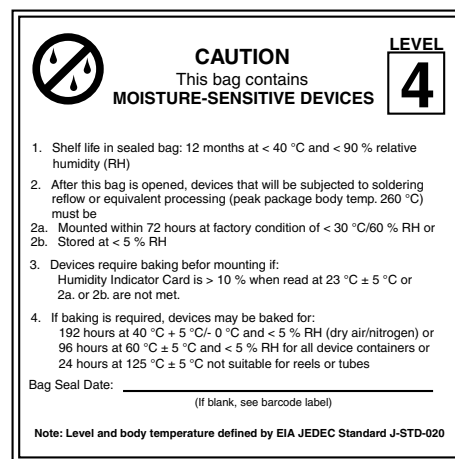
- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or
96 h at 60 °C + 5 °C and < 5 % RH for all device containers or
24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



22522

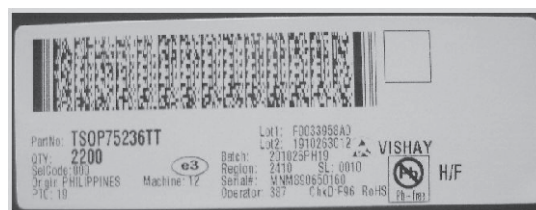
EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS (example)

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22178



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.